

## 2SK2688-01

**FAP-IIS Series** 

N-channel MOS-FET				
30V	$0,017\Omega$	±50A	60W	

#### > Features

- **High Speed Switching**
- Low On-Resistance
- No Secondary Breakdown
- Low Driving Power
- High Voltage
- VGS = ± 30V Guarantee
- Repetitive Avalanche Rated

## > Applications

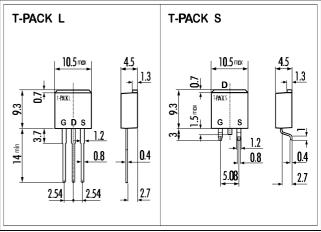
- **Switching Regulators**
- **UPS**
- DC-DC converters
- General Purpose Power Amplifier

## > Maximum Ratings and Characteristics

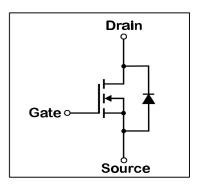
Absolute Maximum Ratings (TC=25°C), unless otherwise specified

Absolute Waximum Ratings (16=26 6);	UTIIC33 OUTICI W	ise specified	
Item	Symbol	Rating	Unit
Drain-Source-Voltage	V <sub>DS</sub>	30	V
Continous Drain Current	ΙD	±50	Α
Pulsed Drain Current	I <sub>D(puls)</sub>	±200	Α
Gate-Source-Voltage	V <sub>GS</sub>	±16	V
Max. Avalanche Energy	E <sub>AV</sub>	520	mJ
Max. Power Dissipation	Pρ	60	W
Operating and Storage Temperature Range	T <sub>ch</sub>	150	°C
	T <sub>sta</sub>	-55 ~ +150	°C
		L=0.277mH Vcc=12V	

## > Outline Drawing



## > Equivalent Circuit



Item	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown-Voltage	BV <sub>DSS</sub>	$I_D=1$ mA $V_{GS}=0$ V	30			V
Gate Threshhold Voltage	V <sub>GS(th)</sub>	$I_D=1$ mA $V_{DS}=V_{GS}$	1,0	1,5	2,0	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}=30V$ $T_{ch}=25^{\circ}C$		10	500	μA
		V <sub>GS</sub> =0V T <sub>ch</sub> =125°C		0,2	1,0	mA
Gate Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±16V V <sub>DS</sub> =0V		10	100	nA
Drain Source On-State Resistance	R <sub>DS(on)</sub>	$I_D=25A$ $V_{GS}=4V$		0,012	0,017	Ω
		$I_D=25A$ $V_{GS}=10V$		0,0075	0,01	Ω
Forward Transconductance	g fs	$I_D=25A$ $V_{DS}=25V$	22	45		S
Input Capacitance	C iss	V <sub>DS</sub> =25V		2750	4130	pF
Output Capacitance	C oss	V <sub>GS</sub> =0V		1300	1950	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f=1MHz		600	900	pF
Turn-On-Time $t_{on} (t_{on} = t_{d(on)} + t_r)$	t <sub>d(on)</sub>	V <sub>CC</sub> =15V		13	20	ns
	t r	I <sub>D</sub> =50A		180	270	ns
Turn-Off-Time $t_{off}(t_{on}=t_{d(off)}+t_{f})$	t d(off)	V <sub>GS</sub> =10V		55	83	ns
	t f	$R_{GS}$ =10 $\Omega$		150	230	ns
Avalanche Capability	I <sub>AV</sub>	$L = 100 \mu H$ $T_{ch} = 25 ^{\circ} C$	50			Α
Diode Forward On-Voltage	V <sub>SD</sub>	$I_F=2xI_{DR}$ $V_{GS}=0V$ $T_{ch}=25$ °C		1,14	1,71	V
Reverse Recovery Time	t <sub>rr</sub>	$I_F = I_{DR}  V_{GS} = 0V$		85	130	ns
Reverse Recovery Charge	Q rr	-dl <sub>F</sub> /dt=100A/µs T <sub>ch</sub> =25°C		0,17		μC

#### Thermal Characteristics

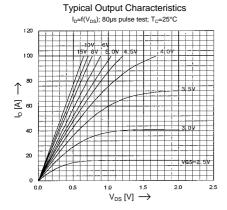
Item	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Thermal Resistance	R th(ch-c)	channel to case			2,08	°C/W
	R <sub>th(ch-a)</sub>	channel to air			125,0	°C/W

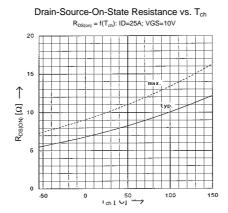
N-channel MOS-FET 30V  $0.017\Omega$   $\pm 50A$  60W

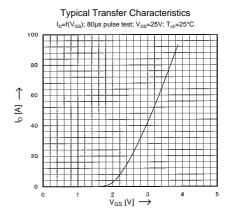
# 2SK2688-01 FAP-IIS Series

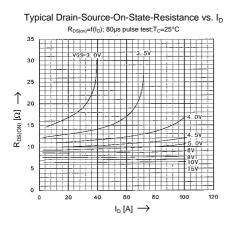
## **FUJ1**

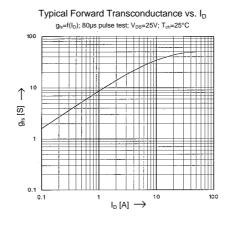
### > Characteristics

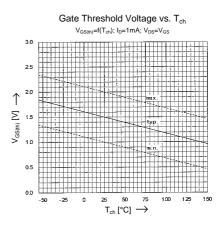


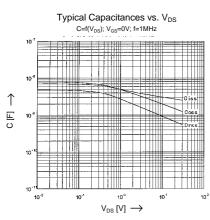


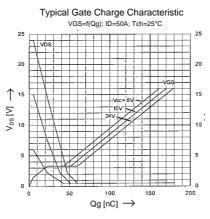


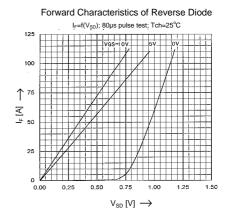


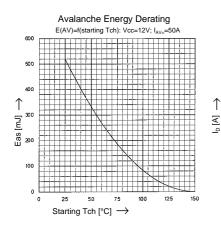


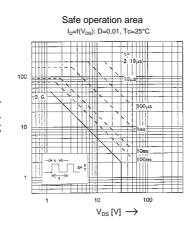


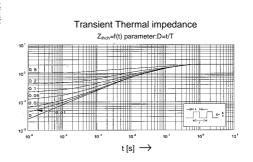








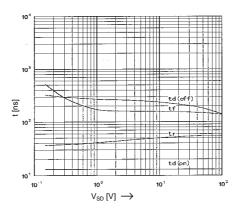


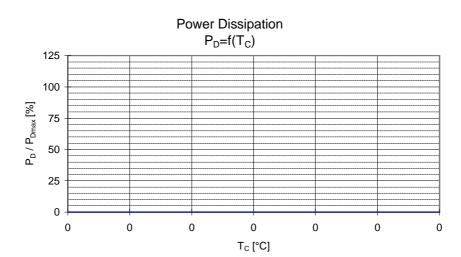




### > Characteristics

Typical Switching Characteristics





 $\label{eq:maximum_avalanche} \mbox{Maximum Avalanche Current vs. starting $T_{ch}$} \\ \mbox{$I_{AV}$=$f(starting $T_{ch}$)$}$ 

